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Approval Sheet		Date : 19-March-2020
Customer		
Customer Part Number		
Description	Bluetooth Stereo Module	
Customer's Project		
Firmware Version		
Manufacturer	Rayson Technology Co., Ltd	
Model Name	BTM923	
Supplier Level : ☒ New Source ☐ Second Source		
Contact Person : _____ -		
Approval status : E.E. engineer : _____ ☒ Approval ☐ Reject M.E. engineer : _____ ☐ Approval ☐ Reject P.E. engineer : _____ ☐ Approval ☐ Reject Approval : _____		

Revision History

[illegible]

Bluetooth® Stereo Audio Module

Introduction

The BTM923 stereo audio module is a Bluetooth v5.0 (BDR/EDR) audio module for designers to add wireless audio and voice applications to their products. This Bluetooth SIG-certified module provides a complete wireless solution with Bluetooth stack, integrated antenna, and worldwide radio certifications in a compact surface mount package.

This stereo module contains a built-in Li-Ion charger and a digital audio interface. It supports HSP, HFP, SPP, A2DP, and AVRCP profiles. Both AAC and SBC Codecs are supported for A2DP.

Note: The customers must connect their own external analog Codec/DSP/amplifier and MCU for audio output.

Figure 1. BTM923 Module

**Features**

- Qualified for Bluetooth v5.0 Specification
 - HFP v1.6, HSP v1.1, A2DP v1.2, AVRCP v1.5, SPP v1.0, PBAP v1.0
 - Bluetooth Classic, Basic Rate/Enhanced Data Rate (BDR/EDR)
- On-Board Embedded Bluetooth Stack
- Easy to Configure with Windows Graphical User Interface (GUI) or Direct by Microcontroller Unit (MCU)
- Compact Surface Mount Module:
 - 29 x 15 x 2.5 mm
 - Castellated surface mount pads

- Integrated 3V and 1.8V Configurable Switching Regulator and LDO
- Built-in Lithium-ion Battery Charger (up to 350 mA)
- Built-in ADC for Battery Monitor and Voltage Sense
- Audio-In/Out
 - BTM923 supports digital audio I2S format
- Transparent Universal Asynchronous Receiver/Transmitter (UART) Mode for Seamless Serial Data Over UART Interface
- Integrated Crystal Oscillator and Matching Circuitry
- Secure AES128 Encryption

RF/Analog

- Frequency Spectrum: 2.402 GHz to 2.480 GHz
- Receive Sensitivity: -91 dB ($\pi/4$ DQPSK)
- Transmitter Output Power: +4 dBm (maximum) for Class 2

Audio processor

- Support 64 Kbps A-Law, μ -Law PCM format/Continuous Variable Slope Delta Modulation (CVSD) for SCO Channel Operation
- Noise Reduction (NR) and Acoustic Echo Cancellation (ACE)
- Sub-Band Coding (SBC) and Optional Advanced Audio Coding (AAC) Decoding
- Packet Loss Concealment (PLC)
- Four Languages (Chinese/ English/ Spanish/ French) Voice Prompts Support (20 events for each language) using the IS20XXS_UI tool
- Serial Copy Management System (SCMS-T) Content Protection

Audio Codec

- 20-Bit Digital-to-Analog Converter (DAC) and 16-bit Analog-to-Digital Converter (ADC) Codec
- 98 dB Signal-to-Noise ratio (SNR) DAC Playback

Peripherals

- One Line-in Port for External Audio Input
- Two LED Drivers
- One UART Interface
- Multiple I/O Pins for Control and Status
- High-Speed HCI-UART Interface (supports up to 921,600 bps)

Antenna

- PCB Antenna

Compliance

- Bluetooth Special Interest Group (SIG) Certified:
 - BTM923 QDID: 121137

- BTM923 modules have been granted modular approval from various countries. For additional details, refer to [9. Certification Notices](#).
- RoHS Compliant

Operating Conditions

- Operating Voltage: 3.0V to 4.2V
- Temperature Range: -20°C to 70°C

Applications

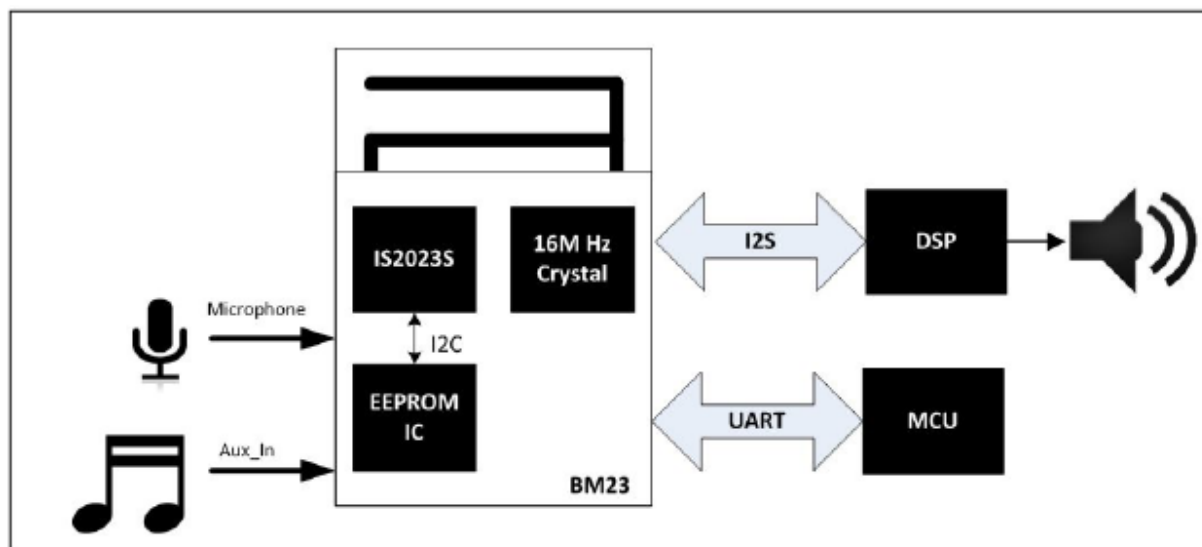
- Bluetooth Sound Bar
- Bluetooth Stereo Speaker Phone

1. Device Overview

The BTM923 stereo module is built around the IS2023S SoC, respectively, which integrates the Bluetooth radio transceiver, a Power Management Unit (PMU), and a Digital Signal Processor (DSP).

The following figure illustrates a typical example of the BTM923 module that operates as an independent system or when connected to an MCU.

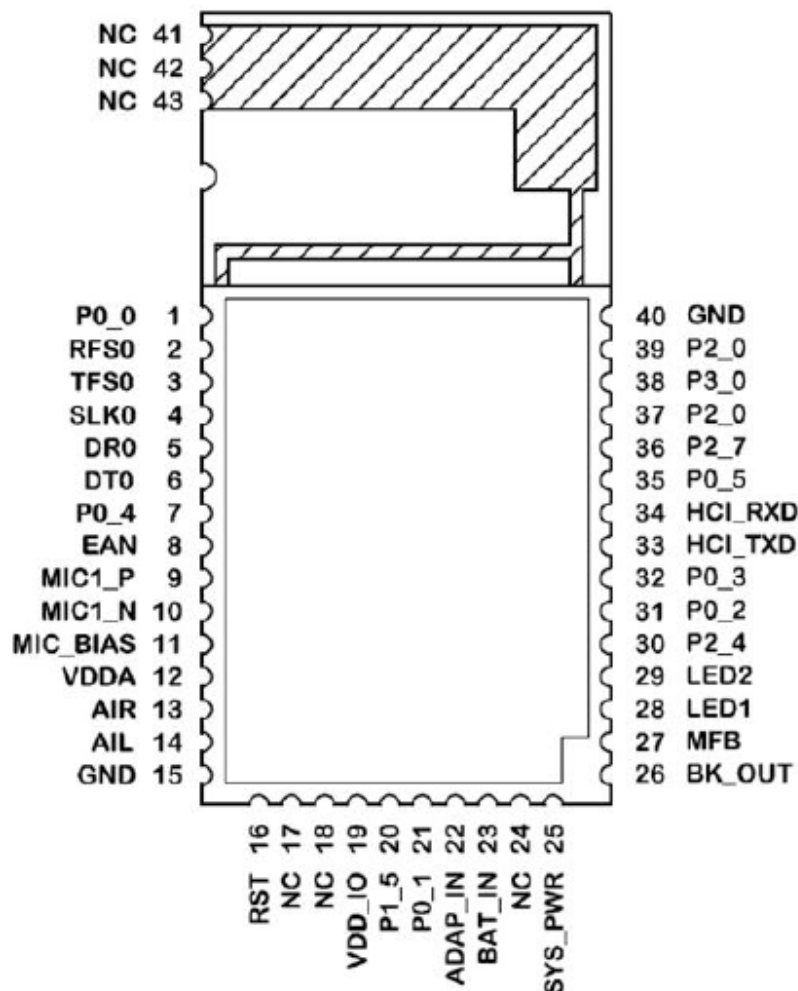
Figure 1-1. BTM923 Typical Application



1.1 Interface Description

The following figure illustrates the pin diagram of the BTM923 module.

Figure 1-3. BTM923 Module Pin Diagram



The following table provides the pin description of the BTM923 module.

Table 1-1. BTM923 Module Pin Description

Pin No.	Name	Pin type	Description
1	P0_0	I/O	- I/O pin, default pull-high input (Note1) - UART TX_IND
2	RFS0	I/O	I2S interface : DAC Left/Right clock
3	TFS0	I/O	I2S interface : ADC Left/Right clock
4	SLK0	I/O	I2S interface : Bit clock
5	DR0	I	I2S interface : DAC Digital Left/Right data
6	DT0	O	I2S interface : ADC Digital Left/Right data
7	P0_4	I/O	I/O pin, default pull-high input

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Device Overview

.....continued			
Pin No.	Name	Pin type	Description
8	EAN	I	Embedded ROM/External Flash enable High : ROM model; Low : External Flash mode
9	MIC1_P	I	MIC 1 mono differential analog positive input
10	MIC1_N	I	MIC 1 mono differential analog negative input
11	MIC_BIAS	P	Power output, microphone biasing voltage
12	VDDA	P	Power output, reserve for external capacitance to fine tune audio frequency
13	AIR	I	Right-channel, single-ended analog input
14	AIL	I	Left-channel, single-ended analog input
15	GND	P	Ground
16	RST	I	System Reset pin, active when rising edge
17	NC	-	-
18	NC	-	-
19	VDDIO	P	Power output, VDDIO pin, no need to add power to this pin
20	P1_5	I/O	I/O pin, default pull-high input
21	P0_1	I/O	I/O pin, default pull-high input
22	ADAP_IN	P	5V Power adapter input
23	BAT_IN	P	3.0V to 4.2V Li-Ion battery input
24	NC	-	-
25	SYS_PWR	P	System power output BAT mode: 3.0 to 4.2V Adapter mode: 4.0V
26	BK_OUT	P	1.8V Buck output, no need to add power to this pin
27	MFB	P	- Power key, when in off mode - UART_RX_IND: MCU used to wake-up Bluetooth
28	LED1	P	LED driver 1 and maximum 4mA
29	LED2	P	LED driver 2 and maximum 4mA
30	P2_4	I	I/O pin, default pull-high input System Configuration, L – Boot Mode with P2_0 low combination
31	P0_2	I/O	I/O pin, default pull-high input
32	P0_3	I/O	I/O pin, default pull-high input
33	HCI_TXD	O	HCI-UART data output
34	HCI_RXD	I	HCI-UART data input

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Device Overview

.....continued			
Pin No.	Name	Pin type	Description
35	P0_5	I/O	I/O pin, default pull-high input
35	P2_7	I/O	I/O pin, default pull-high input
37	P2_0	I/O	I/O pin, default pull-high input
38	P3_0	I/O	I/O pin, default pull-high input
39	P2_0	I	I/O pin, default pull-high input System Configuration, H: Application L: Base band (Test Mode)
40	GND	P	Ground
41	NC	-	-
42	NC	-	-
43	NC	-	-

- I: Input pin
- O: Output pin
- I/O: Input/Output pin
- P: Power pin

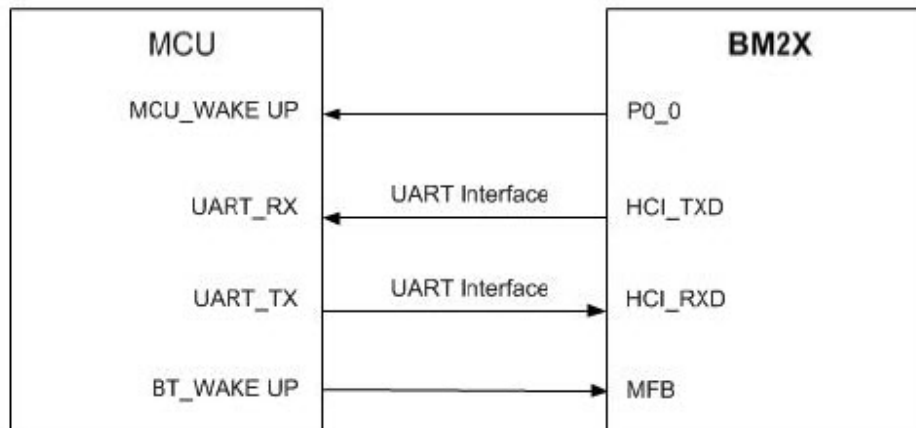
Note: All I/O pins can be configured using the IS20XXS_UI tool.

2. Application Information

2.1 Operation with External MCU

The BTM923 stereo module supports a UART command set to make an external MCU control the module. The following figure illustrates the interface between the BTM923 module and an external MCU.

Figure 2-1. Interface between MCU and BTM923 Module

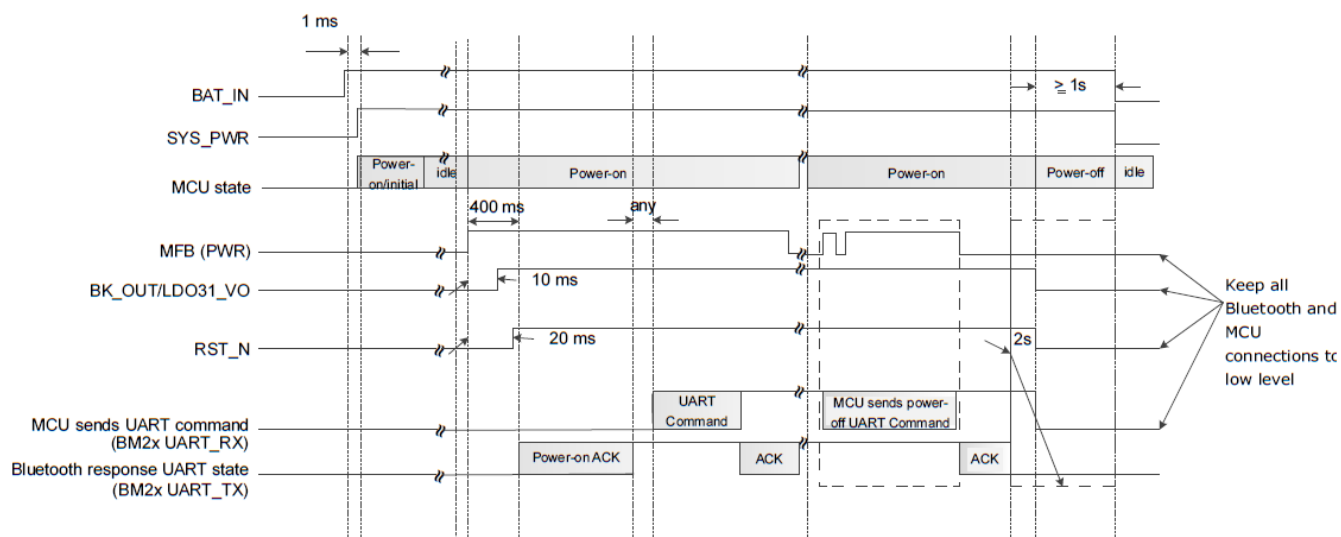


The MCU controls the module by the UART interface and wakes up the module by the PWR pin. The stereo module provides a wake-up MCU function that connects to P0_0 pin of the module.

Refer to the *UART Command Set* document for a list of functions the BTM923 module supports and how to use the UI tool to configure the UART and UART Command Set tool.

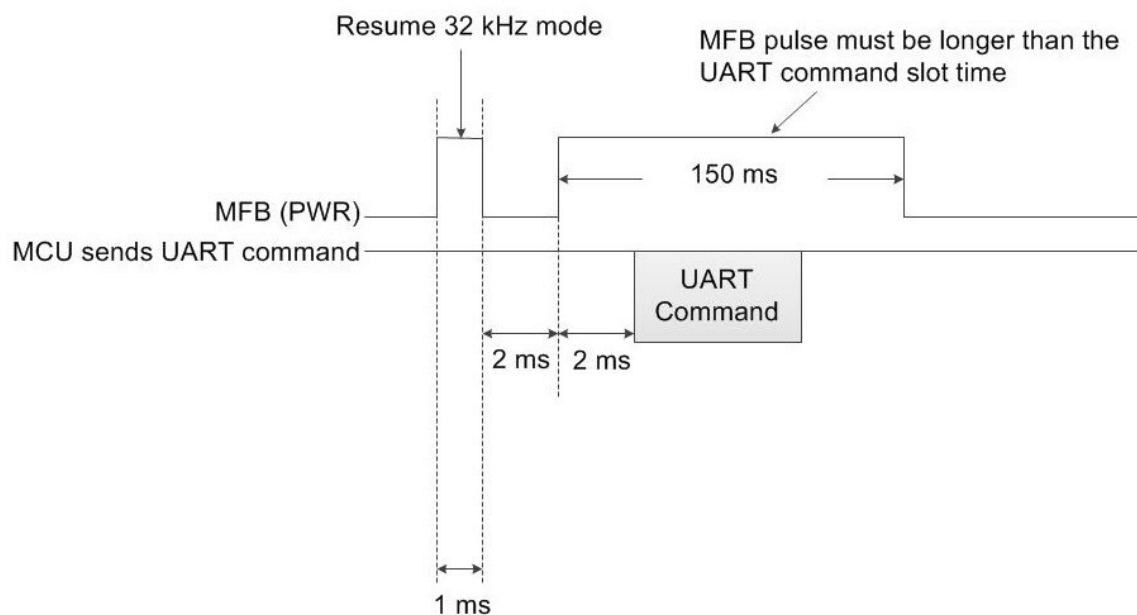
For a more detailed description, refer to the *UART_CommandSet_v154* document and the IS20XXS_UI tool. A UART control signal timing sequence is illustrated in the following figure.

Figure 2-2. Power ON/OFF Sequence



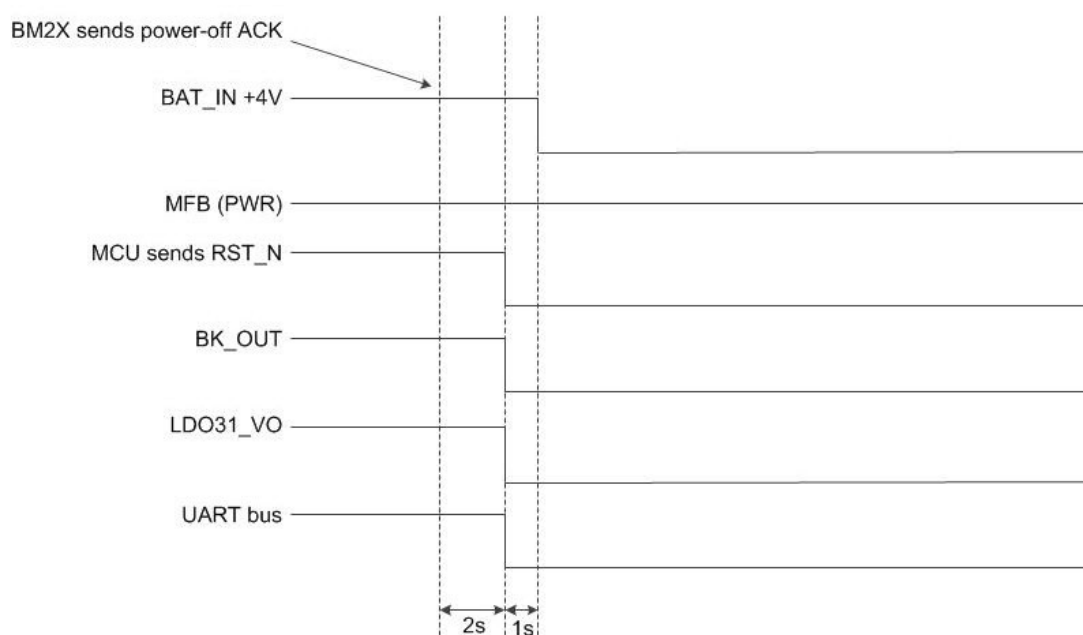
A timing sequence of Rx indication after power-on is illustrated in the following figure.

Figure 2-3. Timing Sequence of Rx Indication After Power-On



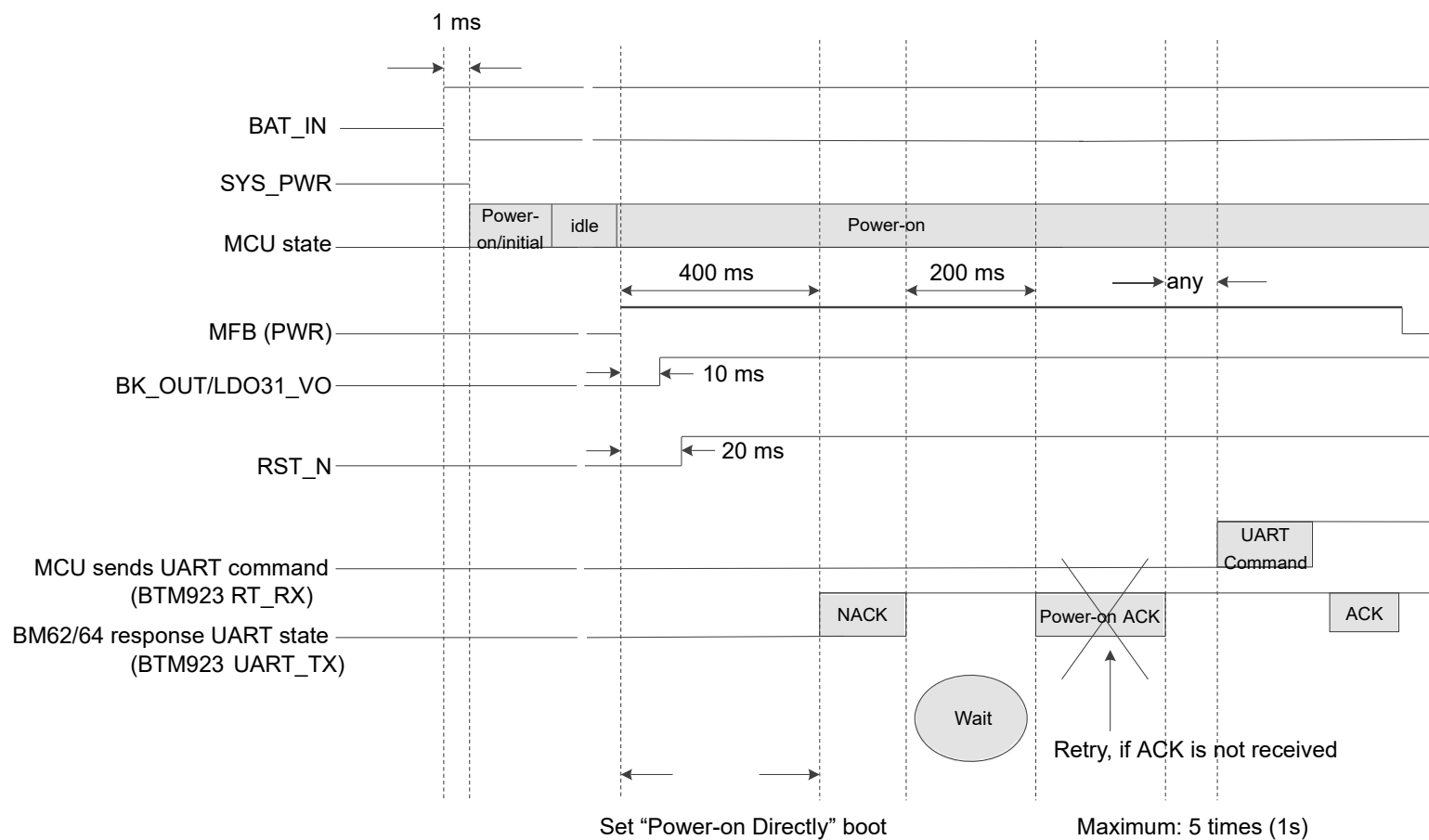
A timing sequence of Rx indication after power-off is illustrated in the following figure.

Figure 2-4. Timing Sequence of Rx Indication After Power-Off



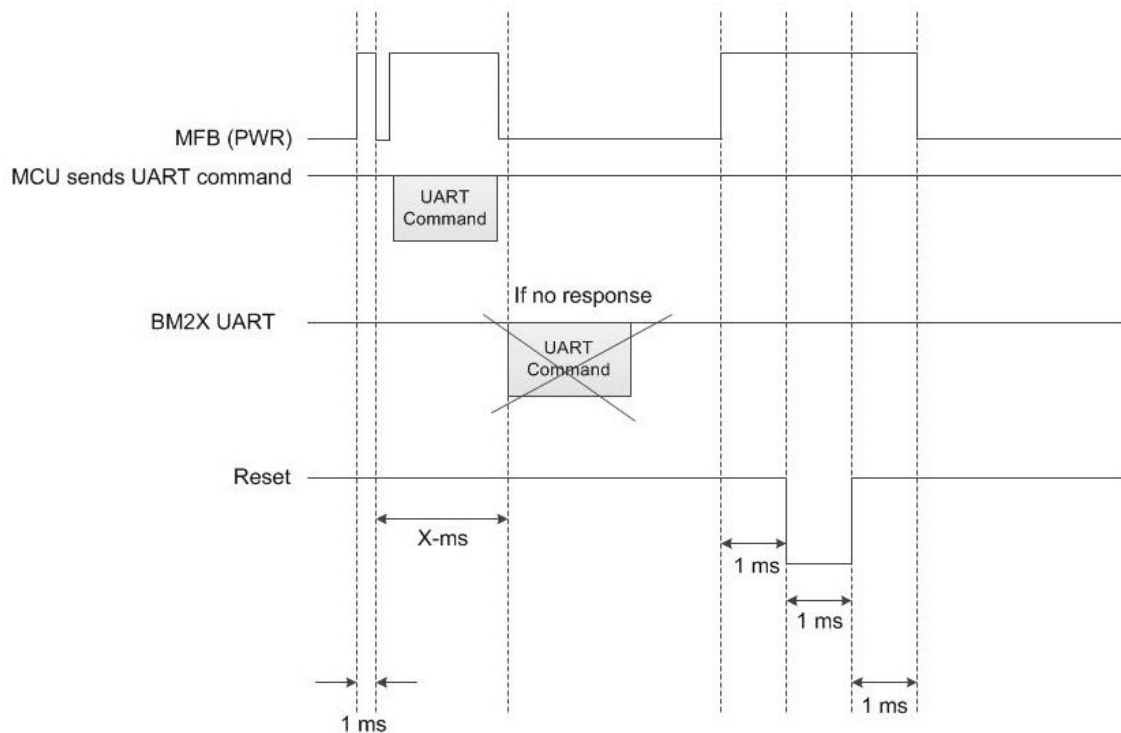
A timing sequence of power-on (Nack) is illustrated in the following figure.

Figure 2-5. Timing Sequence of Power-On (Nack)



If the module is hanged, the reset timing sequence must be as illustrated in the following figure.

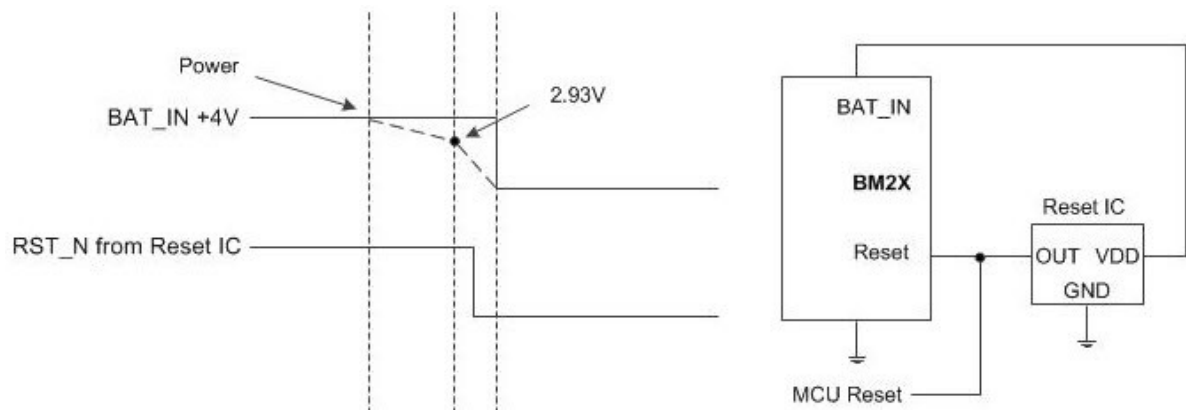
Figure 2-6. Reset Timing Sequence if Module is Hanged



If the MCU sends a UART Command and Bluetooth does not respond within X-ms, then the MCU sends a reset signal to BT to perform the hardware reset.

A timing sequence of power drop protection is illustrated in the following figure.

Figure 2-7. Timing Sequence of Power Drop Protection



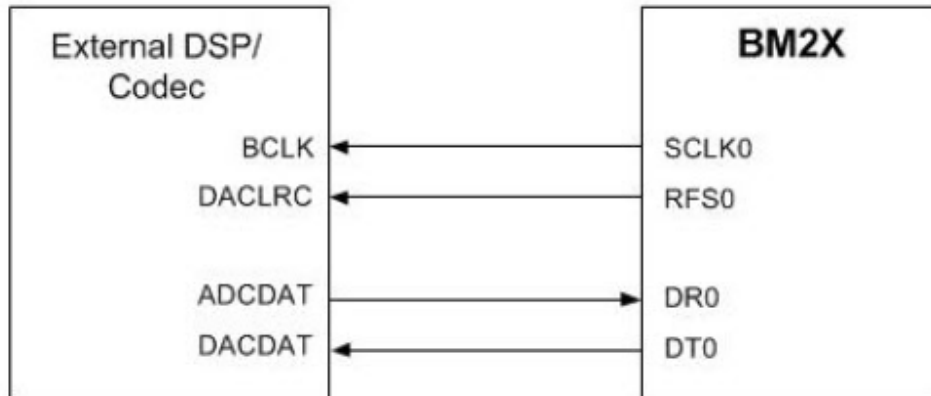
If the Bluetooth BAT uses an adapter that translates voltage by LDO, it is recommended to use "Reset IC" to avoid power-off suddenly. The Rest IC output pin must be "Open Drain" with a delay time ≤ 10 ms and the recommended part is TCM809SVNB713 or G691L263T73.

2.2 I2S Mode Application

The BTM923 module provides an I2S digital audio signal interface to connect with an external Codec/DSP. It provides 8, 44.1 and 48kHz sampling rates for 16-bit and 24-bit data formats. The I2S setting can be configured by using the UI and DSP tools.

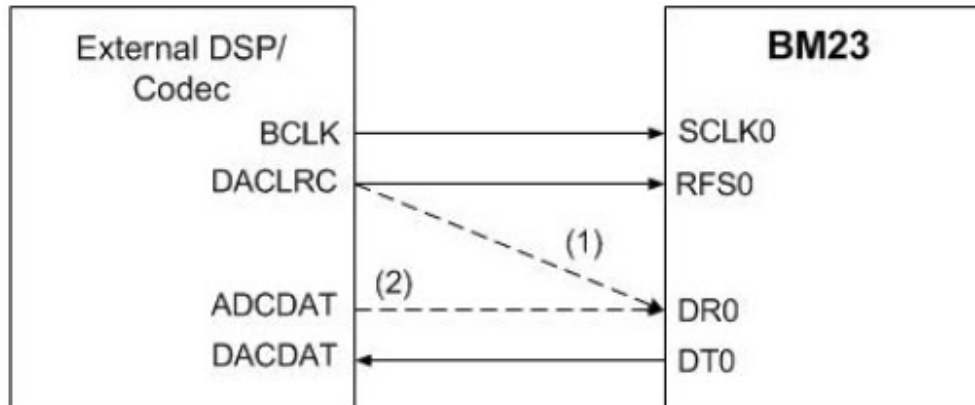
The external Codec/DSP is connected to SLK0, RFS0, TFS0, DR0, and DT0 (pins 4, 2, 3, 5, and 6 respectively). The I2S signal connection between the BM23 and external DSP is illustrate in the flowing figure.

Figure 2-8. Master Mode Reference Connection



The Slave mode reference connection is shown in the following figure.

Figure 2-9. Slave Mode Reference Connection

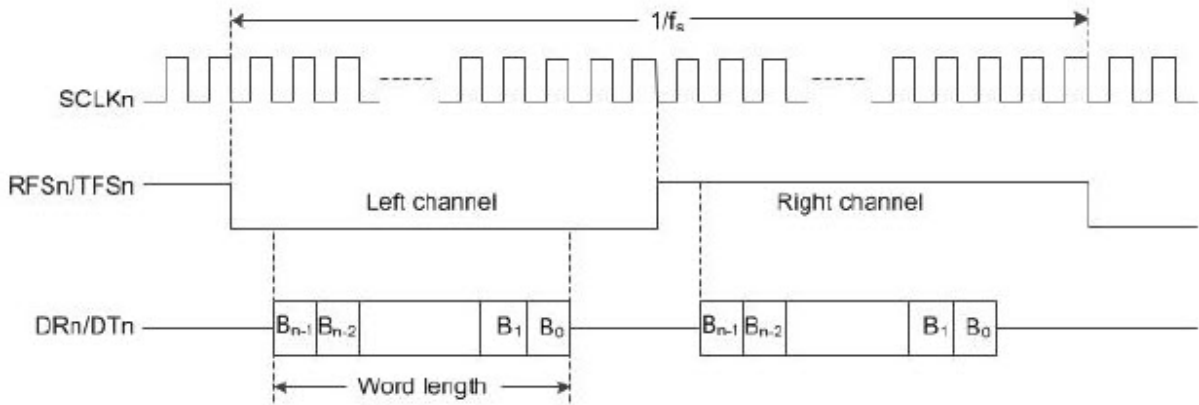


Note:

1. For 002 version chip or module, the system must connect line 1 in the above figure.
2. For other version chip or module, the system must connect line 2 in the above figure.

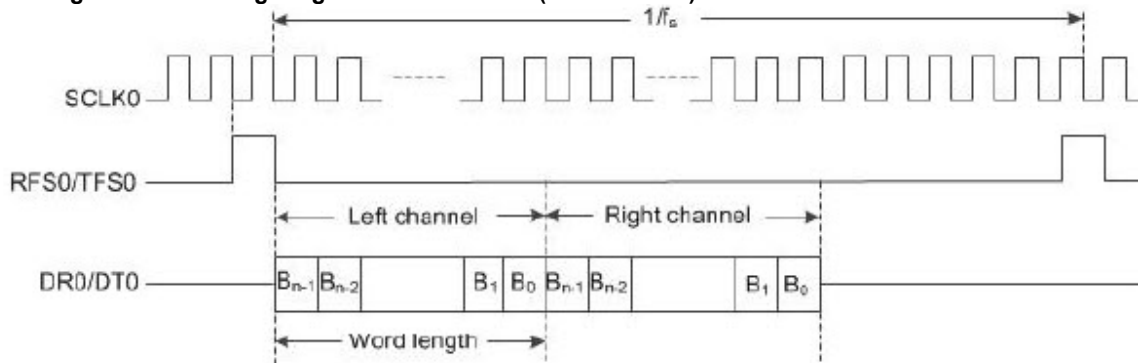
For Master or Slave mode setting, use the DSP Configuration Tool to set up the system. The following figures illustrate the clock and data timing diagram.

Figure 2-10. Timing for I2S Mode (both Master and Slave)



The following figures illustrate the timing diagram in the PCM modes.

Figure 2-11. Timing Diagram for PCM Mode (Master/Slave)



2.3 RESET (RST_N)

RST is the module reset pin, which is in Active-Low state. To reset the module, the RST_N pin must hold LOW for at least 63 ns.

2.4 Status LED (LED1, LED2)

The status LED provides the following status indications:

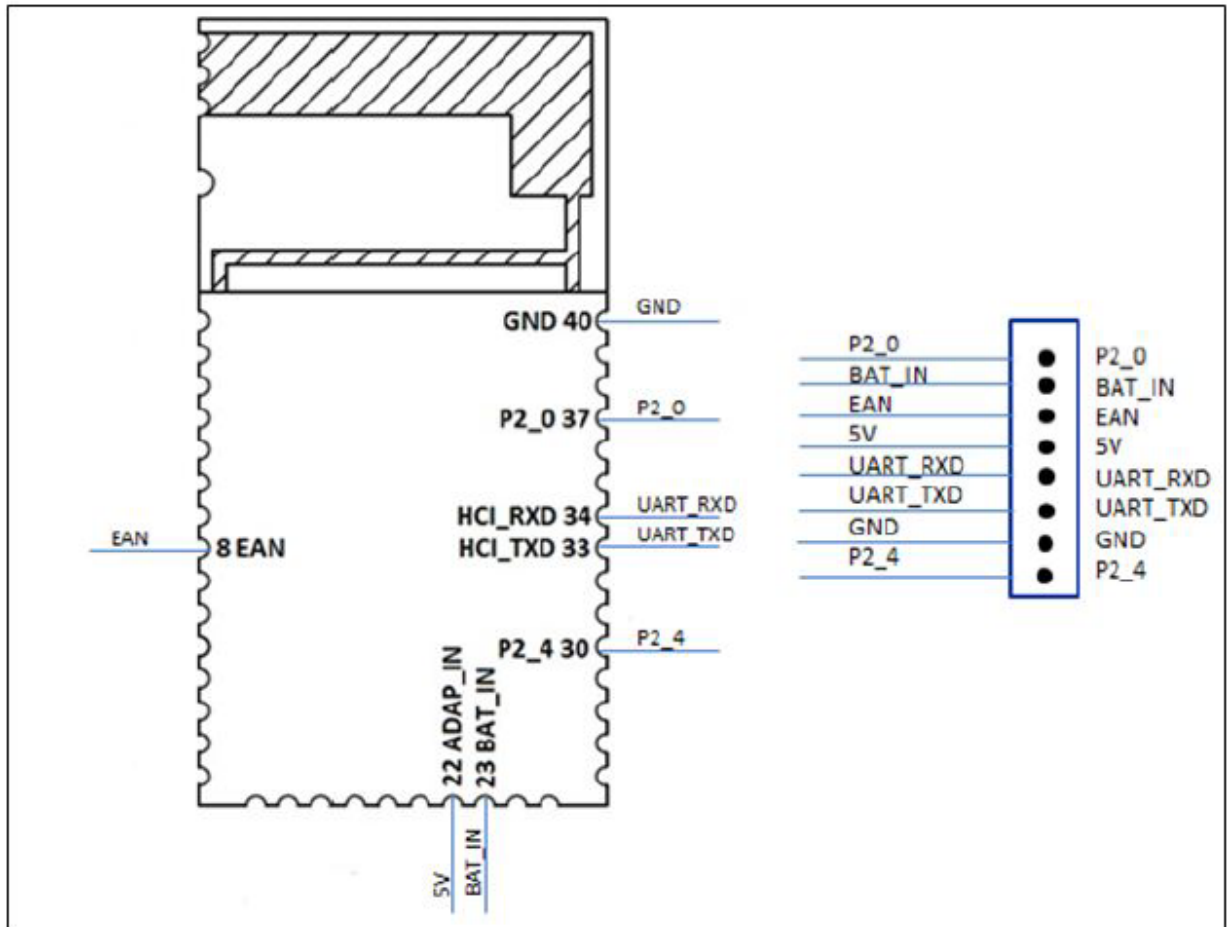
- Standby
- Inquiry
- Link
- Link Back
- Low Battery
- Page
- Battery Charging

Note: Each LED flashing sequence and brightness status indications are configurable by the UI tool.

2.5 External Configuration

The BTM923 stereo module can be configured and the firmware programmed using an external configuration and programming tool available from Microchip. The following figure illustrates the configuration and firmware programming interface on BTM920. It is recommended to include a pin header on the main PCB for development.

Figure 2-12. External Programming Header Connections



Configuration and firmware programming modes are entered according to the system configuration I/O pins as shown in the following table. Pins P20, P24 and EAN contain internal pull-up.

Table 2-1. System Configuration Settings

P20	P24	EAN	Operational Mode
High	High	High	APP mode (Normal operation)
Low	High	High	APP mode (Normal operation)
Low	Low	High	Write Flash (Firmware programming, if flash build-in in chip)

3. Electrical Characteristics

The following table provides the absolute maximum specification conditions of the BTM920 module.

Table 3-1. Absolute Maximum Specification

Symbol	Parameter	Min.	Max.	Unit
BAT_IN	Input voltage for battery	0	4.3	V
ADAP_IN	Input voltage for adapter	0	7.0	V
T _{STORE}	Storage temperature	-65	+150	°C
T _{OPERATION}	Operation temperature	-20	+70	°C

The following table provides the recommended operating condition of the BTM920 module.

Table 3-2. Recommended Operating Condition

Symbol	Parameter	Min.	Typical	Max.	Unit
BAT_IN	Input voltage for battery	3	3.7	4.2	V
ADAP_IN	Input voltage for adapter	4.5	5	5.5	V
T _{OPERATION}	Operation temperature	-20	+25	+70	°C

Note: The absolute and recommended operating condition tables reflect typical usage for device.

CAUTION Stresses listed under Absolute Maximum Ratings cause permanent damage to the device. This is a stress rating only. The functional operation of the device at those or any other conditions and those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods affects the device reliability.

The parameters of the I/O and reset level are shown in the following table.

Table 3-3. I/O and Reset Level

Parameter	Min.	Typ.	Max.	Units
I/O supply voltage (VDD_IO)	2.7	-	3.3	V
I/O Voltage Levels				
V _{IL} input logic levels low	- 0.3	-	0.8	V
V _{IH} input logic levels high	2.0	-	3.6	V
V _{OL} output logic levels low	-	-	0.4	V
V _{OH} output logic levels high	2.4	-	-	V
RESET				
V _{TH,RES} threshold voltage	-	1.6	-	V

Note:

1. VDD_IO voltage is programmable by EEPROM parameters.
2. These parameters are characterized but not tested in manufacturing.

The parameters of the battery charger are shown in the following table.

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Electrical Characteristics

Table 3-4. Battery Charger

Parameter		Min	Typical	Max	Unit
ADAP_IN input voltage		4.5	5.0	5.5	V
Supply current to charger only		-	3	4.5	mA
Maximum battery Fast charge current Note: ENX2=0	Headroom > 0.7V (ADAP_IN=5V)	170	200	240	mA
	Headroom = 0.3V (ADAP_IN=4.5V)	160	180	240	mA
Maximum battery Fast charge current Note: ENX2=1	Headroom > 0.7V (ADAP_IN=5V)	330	350	420	mA
	Headroom = 0.3V (ADAP_IN=4.5V)	180	220	270	mA
Trickle charge voltage threshold		-	3	-	V
Battery charge termination current, (% of fast charge current)		-	10	-	%

Note:

1. Headroom = VADAP_IN – VBAT
2. ENX2 is not allowed to be enabled, when VADAP_IN – VBAT > 2V
3. These parameters are characterized but not tested in manufacturing

The parameters of the LED driver are shown in the following table.

Table 3-5. LED driver

Parameter	Min	Typical	Max	Unit
Open-drain voltage	-	-	3.6	V
Programmable current range	0	-	5.25	mA
Intensity control	-	16	-	Step
Current step	-	0.35	-	mA
Power down open-drain current	-	-	1	μA
Shutdown current	-	-	1	μA

Note:

1. Test condition: SAR_VDD = 1.8V, temperature = 25 °C.
2. These parameters are characterized but not tested in manufacturing.

The parameters of the audio Codec ADC are provided in the following table.

T= 25°C, V_{dd} = 3.0V, 1 kHz sine wave input, Bandwidth = 20 Hz to 20 kHz.

Table 3-6. Audio Codec ADC

Parameter (Condition)	Min.	Typ.	Max.	Unit
Resolution	-	-	16	Bits
Output sample rate	8	-	48	kHz

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Electrical Characteristics

.....continued

Parameter (Condition)	Min.	Typ.	Max.	Unit
Signal-to-Noise Ratio Note: 1 (SNR at MIC or Line-in mode)		88	-	dB
Digital gain	-54		4.85	dB
Digital gain resolution	-	2 to 6	-	dB
MIC boost gain	-	20	-	dB
Analog gain	-	-	60	dB
Analog gain resolution	-	2.0	-	dB
Input full-scale at maximum gain (differential)	-	4	-	mV rms
Input full-scale at minimum gain (differential)	-	800	-	mV rms
3 dB bandwidth	-	20	-	kHz
Microphone mode (input impedance)	-	24	-	kOhm
THD+N (microphone input) at 30 mV/rms input	-	0.02	-	%

Note:

- $f_{in} = 1$ kHz, B/W = 20 Hz to 20 kHz, A-weighted, THD+N < 1%, 150 mV_{pp} input.
- These parameters are characterized but not tested in manufacturing.

The parameters of the audio Codec DAC are provided in the following table.

T = 25°C, V_{dd} = 3.0V, 1 kHz sine wave input, Bandwidth = 20 Hz to 20 kHz

Table 3-7. Audio Codec DAC

Parameter	Min.	Typ.	Max.	Unit
Over-sampling rate	-	128	-	f _s
Resolution	16	-	20	Bits
Output sample rate	8	-	48	kHz
Signal-to-Noise Ratio (Note: 1) (SNR at Capless mode) for 48 kHz	-	96	-	dB
Signal-to-Noise Ratio (Note: 1) (SNR at Single-Ended mode) for 48 kHz	-	98	-	dB
Digital gain	-54	-	4.85	dB
Digital gain resolution	-	2 to 6	-	dB
Analog gain	-28	-	3	dB
Analog gain resolution	-	1	-	dB
Output voltage full-scale swing (AVDD=2.8V) (Note: 3)	-	742.5	-	mV/rms
Maximum output power (16 Ohm load)	-	34.5	-	mW

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Electrical Characteristics

.....continued

Parameter	Min.	Typ.	Max.	Unit
Maximum output power (32 Ohm load)	-	17.2	-	mW
Allowed load (Resistive)	8	16	O.C.	Ω
Allowed load (Capacitive)	-	-	500	pF
THD+N (16 Ohm load)	-	-	0.05	%
Signal-to-Noise Ratio (SNR at 16 Ohm load)	-	-	96	dB

Note:

1. $f_{in} = 1$ kHz, B/W = 20 Hz to 20 kHz, A-weighted, THD+N < 0.01%, 0 dBFS signal, Load = 100 kOhm.
2. These parameters are characterized but not tested in manufacturing.
3. V_{dd} and AVDD are generated by internal LDO.

The parameters of the transmitter section for BDR and EDR are shown in the following table.

Test condition: VCC_RF = 1.28V, temperature = 25°C.

Table 3-8. Transmitter section for BDR and EDR

Parameter	Min.	Typ.	Max.	Bluetooth specifications	Unit
Maximum RF transmit power (BTM923)	-	2	-	-6 to 4	dB
EDR/BDR Relative transmit power	-4	-1.2	1	-4 to 1	dB

Note: The RF Transmit power is calibrated during production using MP Tool software and MT8852 Bluetooth Test equipment.

The parameters of the receiver section for BDR and EDR are shown in the following table.

Test condition: VCC_RF = 1.28V, temperature = 25°C.

Table 3-9. Receiver Section for BDR and EDR

Parameters	Modulation	Min.	Typ.	Max.	Bluetooth Specification	Unit
Sensitivity at 0.1% BER	GFSK	-	-90	-	≤ -70	dBm
Sensitivity at 0.1% BER	$\pi/4$ DQPSK	-	-91	-	≤ -70	dBm
	8DPSK	-	-82	-	≤ -70	dBm

Note: These parameters are characterized but not tested in manufacturing.

The parameters of system current consumption of analog audio output are shown in the following table.

Test condition: BAT_IN = 3.8V, link with HTC EYE cell phone; distance between cell phone and EVB is 30 cm.

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Electrical Characteristics

Table 3-10. System Current Consumption of Digital Audio Output

System Status	Typ.	Max.	Unit
System off mode	2	5	μA
Standby mode	0.4	-	mA
Linked mode	0.4	-	mA
SCO link	9.3	-	mA
A2DP link (1k tone signal)	11.7	-	mA

Note: Use BTM923 EVB as a test platform.

The parameters of system current consumption of digital audio output are shown in the following table.

Test condition: BAT_IN = 3.8V, link with HTC M8 cell phone; distance between cell phone and EVB is 30 cm; I²S signal link with YAMAHA YDA174 EVB.

4. Printed Antenna Information

4.1 Module Radiation Pattern

The stereo module contains a PCB printed antenna. The PCB printed antenna radiation pattern is illustrated in the following figure.

Figure 4-1. Antenna Keep Out Area Examples

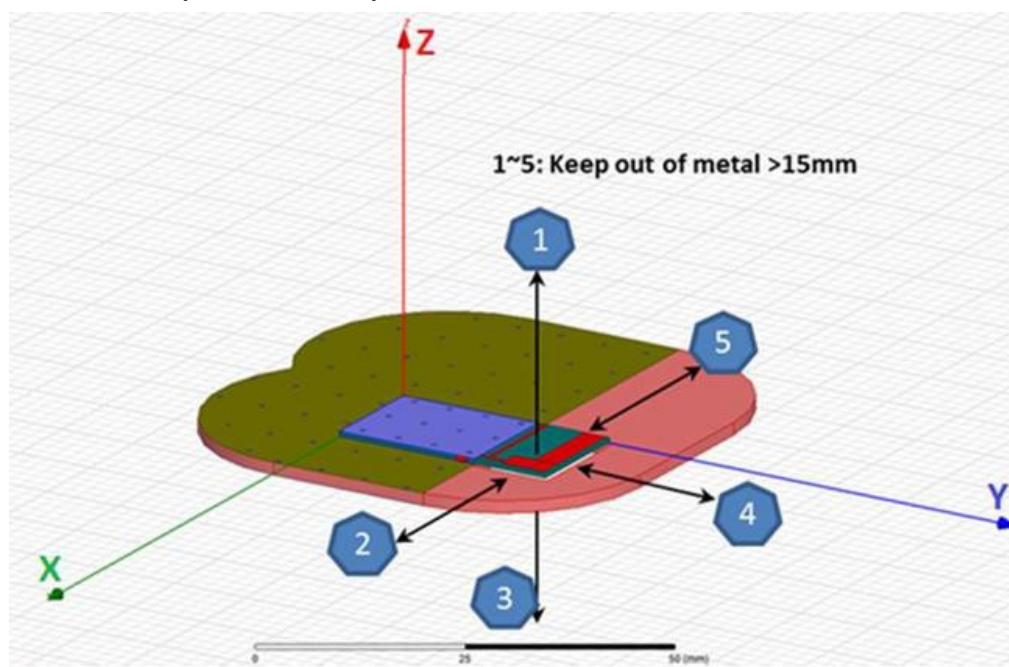
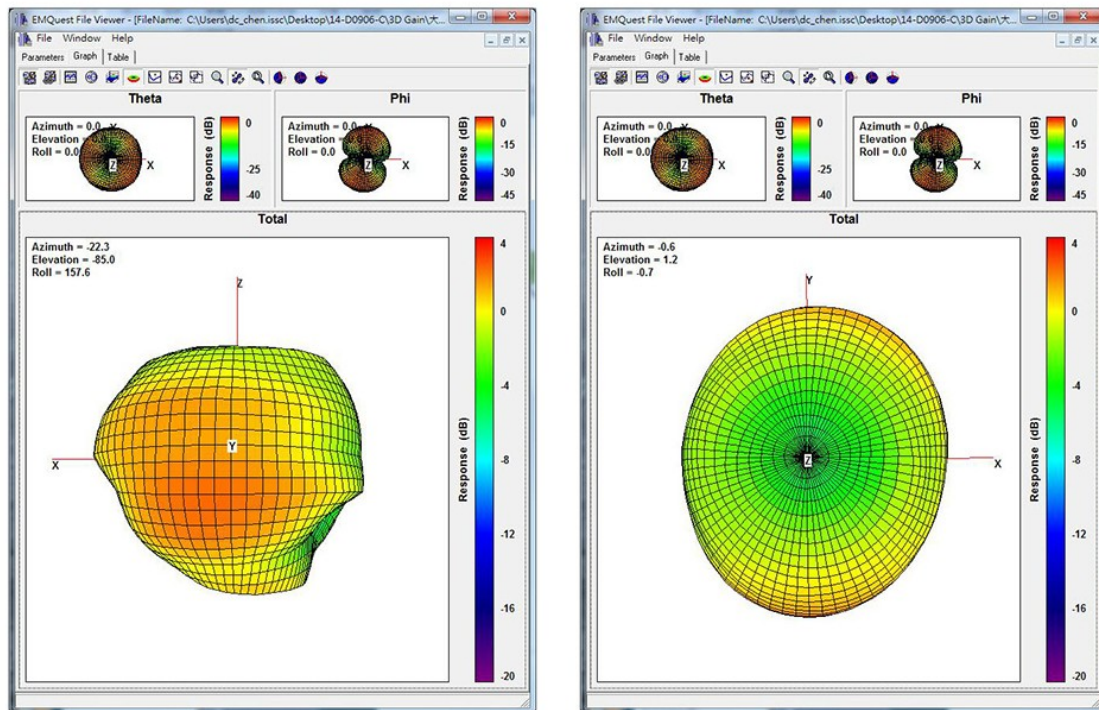


Figure 4-2. PCB Antenna 3D Radiation Pattern at 2441 MHZ



The following table provides the details of BTM923 PCB Antenna characteristics.

Table 4-1. BTM920 PCB Antenna Characteristics

Parameter	Values
Frequency	2400 MHz to 2480 MHz
Peak Gain	1.927 dBi
Efficiency	73.41%

4.2 Module Placement Rules

On the main PCB, the areas under the antenna should not contain any top, inner layer, or bottom copper as shown in the below figure. A low - impedance ground plane will ensure the best radio performance (best range, lowest noise). The ground plane can be extended beyond the minimum recommended as needed for the main PCB EMC noise reduction. For the best range performance, keep all external metal at least 15 mm away from the ceramic chip antenna.

Figure 4-3. Module Placement Examples

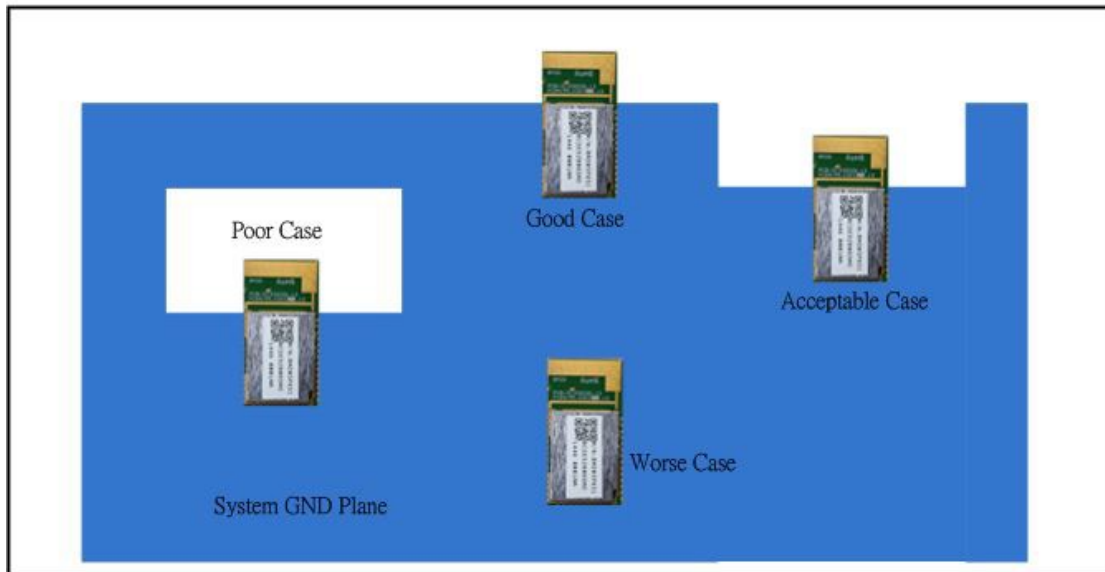
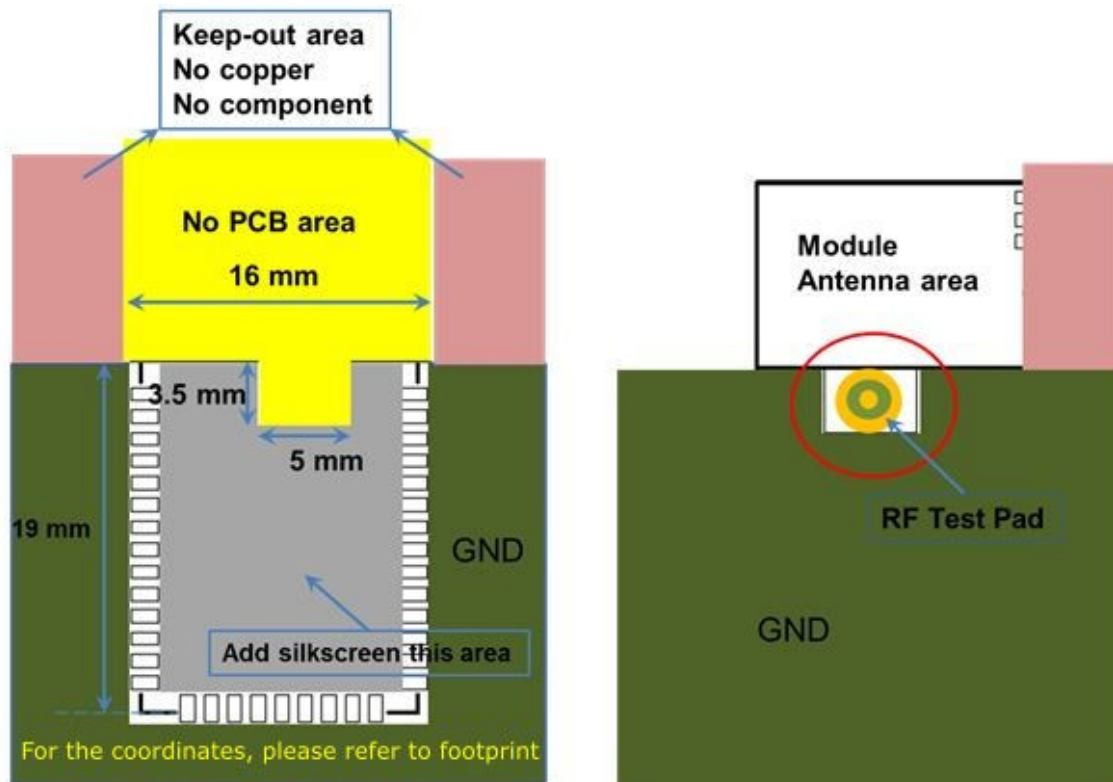


Figure 4-4. GND Plane on Main Application Board



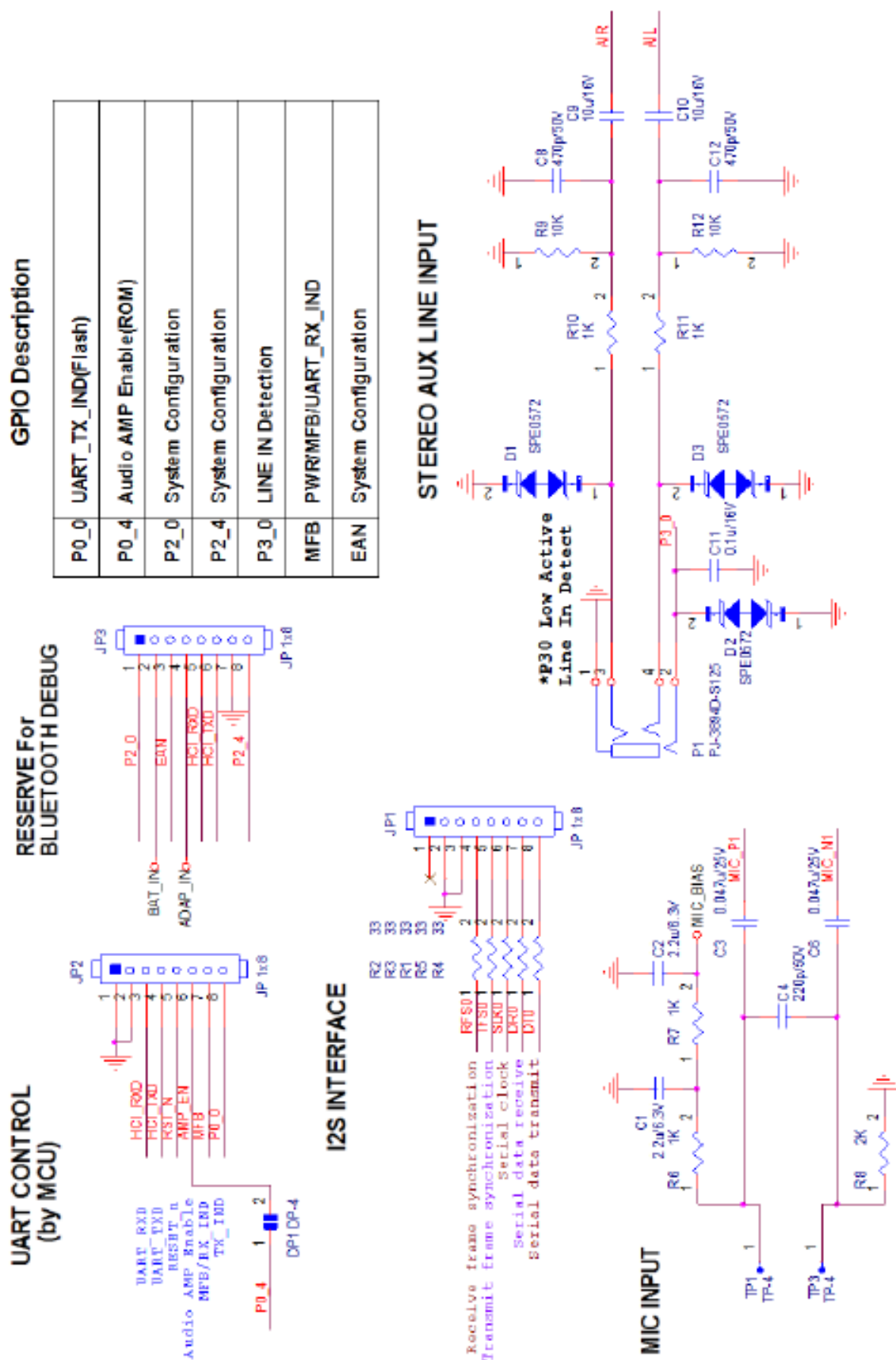
5. Reference Circuit

This section provides the reference schematics of BTM923 modules.

5.1 BTM923 Reference Circuit

The following figures illustrate the reference schematics of the BTM923 module.

Figure 5-3. BM23 Reference circuit



BTM923

Reference Circuit

Figure 5-2. BTM923 Reference Circuit

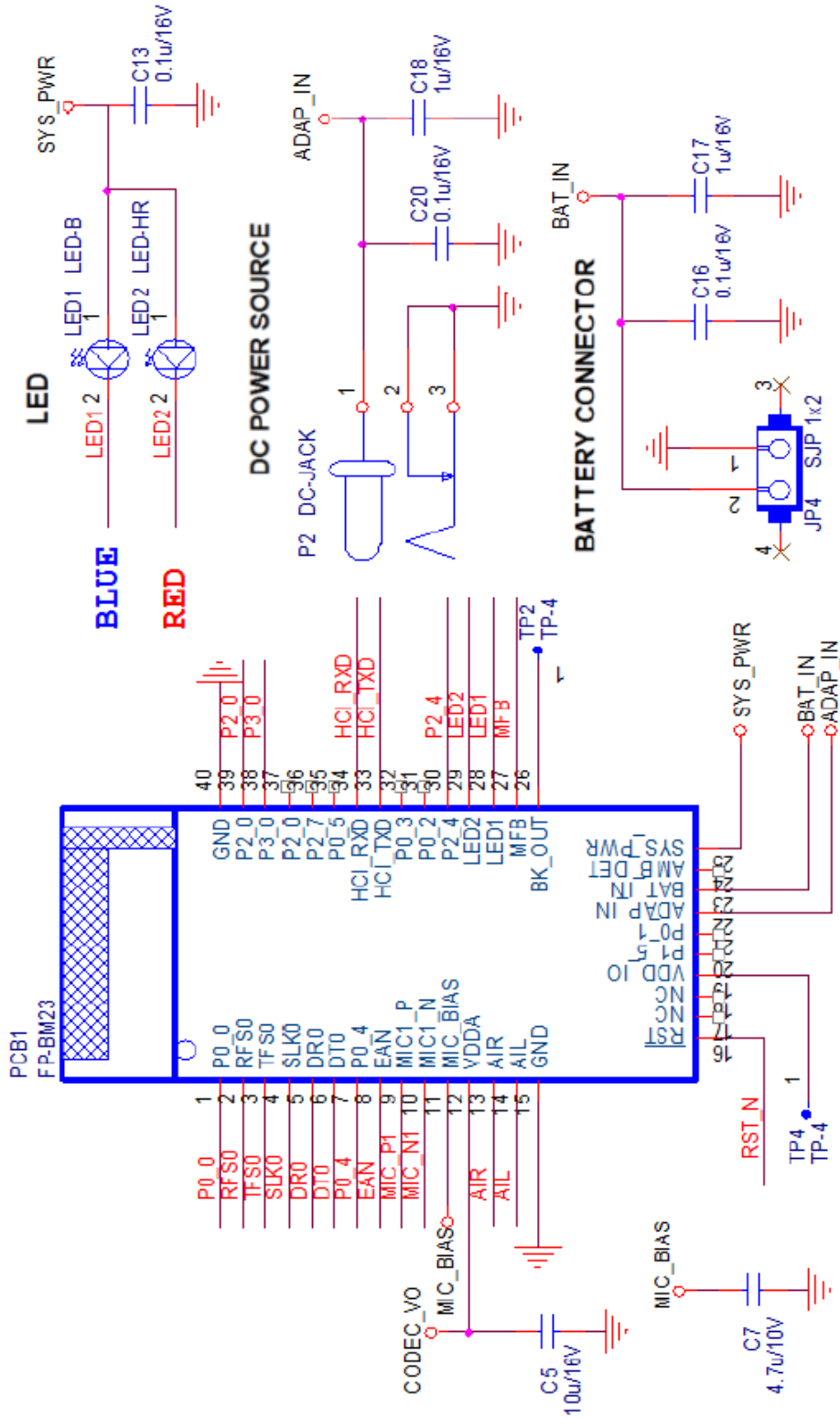
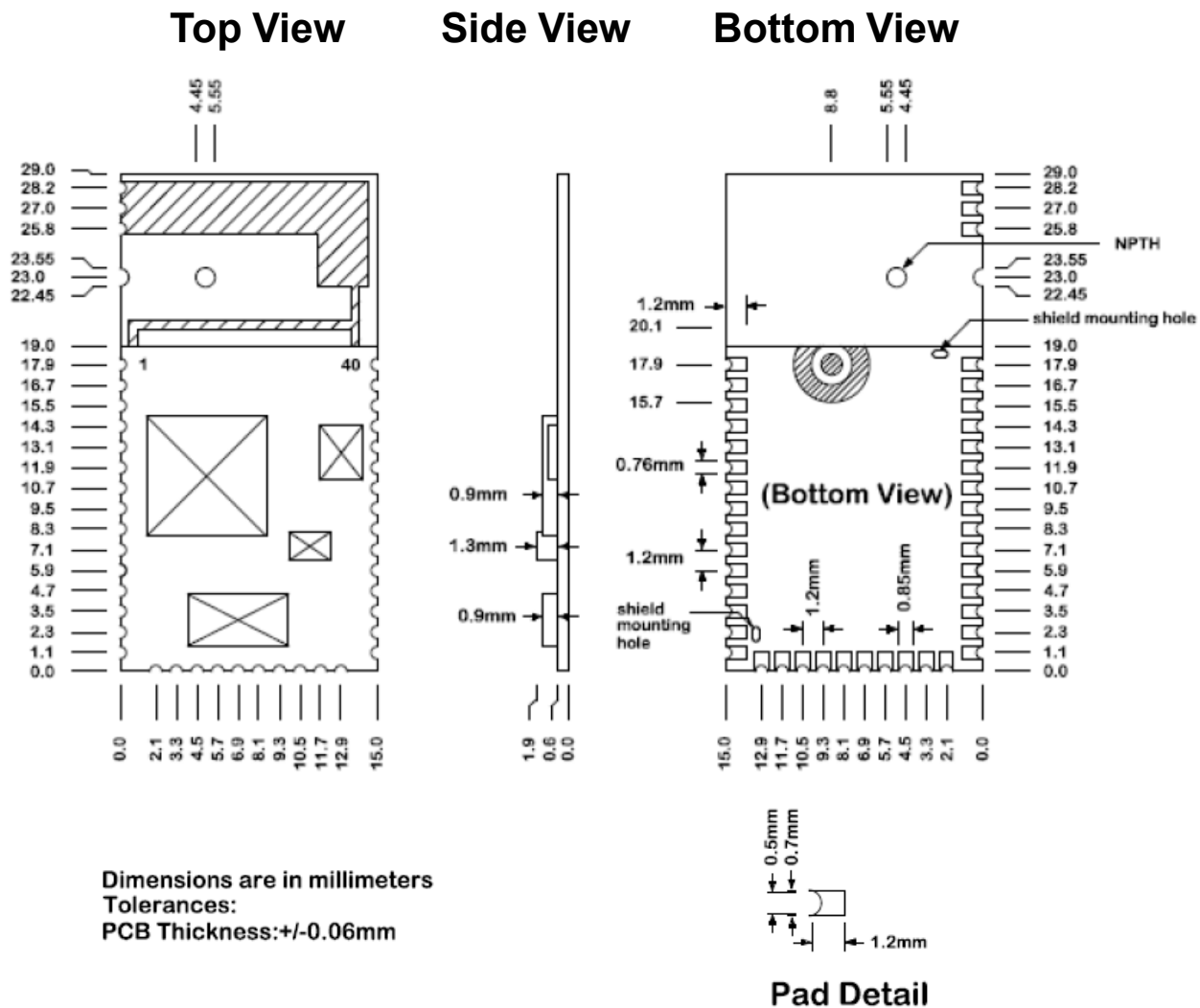


Figure 5-4. BM23 Reference circuit

6. Physical Dimensions

The following figure shows the PCB dimension of BTM923 module.

Figure 6-1. BTM923 Module PCB dimension

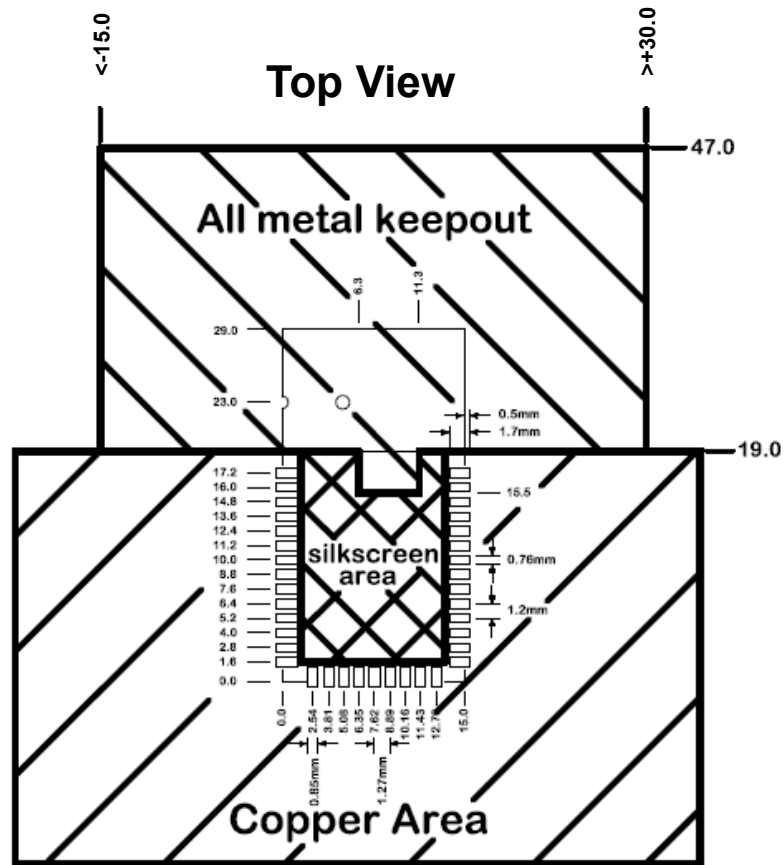


PCB dimension:

- X: 15.0 mm
- Y: 29.0 mm
- Tolerances: 0.25 mm

The following figure shows the PCB dimension of BM23 module.

Figure 6-3. BTM923 module PCB Footprint



- Note 1:** The keep-out area is reserved to keep the RF test point away from GND plane.
Note 2: All metal keep-out is used to isolate the PCB antenna.

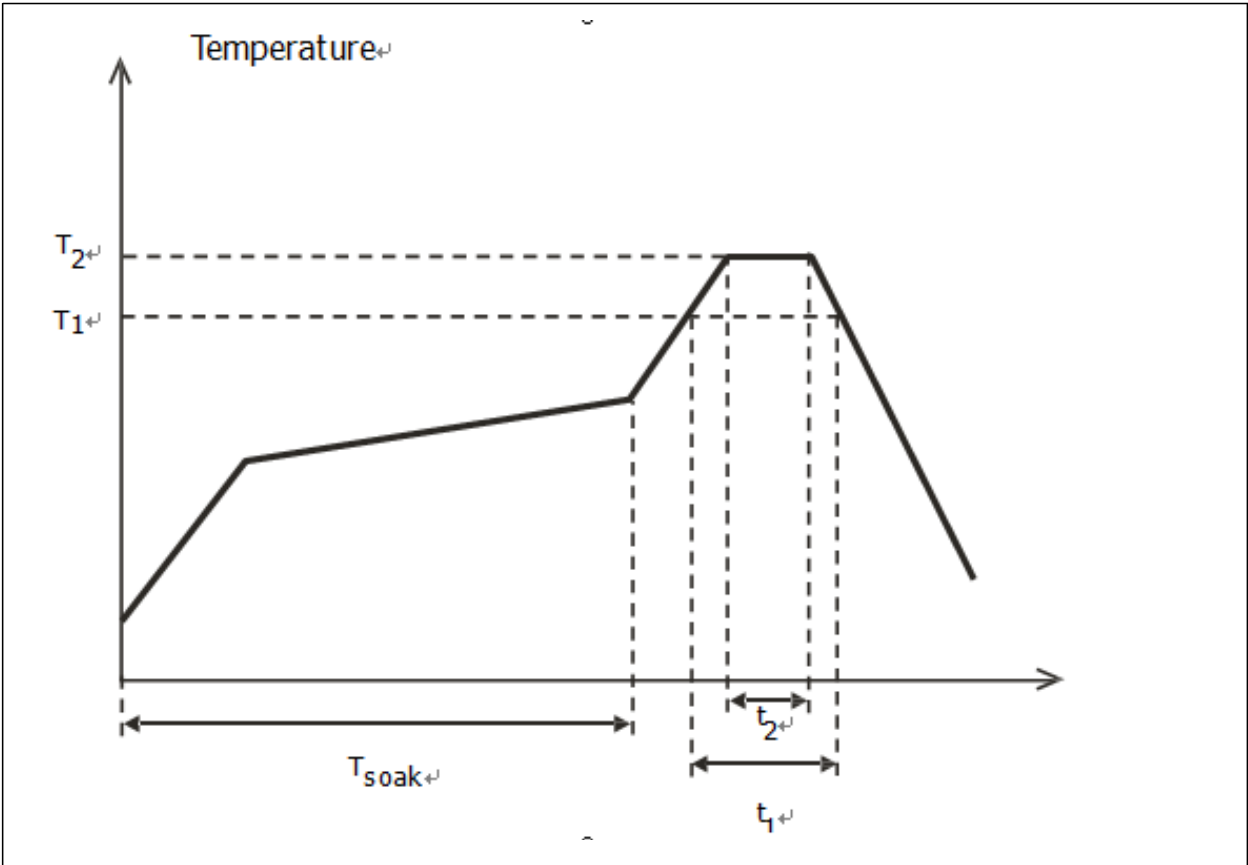
7. Reflow Profile

The following figure illustrates the reflow profile of the BTM923 module.

Figure 7-1. Reflow Profile

Reflow profile requirements		
Parameter Specification	Reference	Specification
Average temperature gradient in preheating		1~2.5°C/s to 175°C equilibrium.
Soak time	T_{soak}	120~180 seconds
Time above 217°C (T_1)	t_1	45~90 seconds
Peak temperature in reflow	T_2	250°C (-0/+5°C)
Time at peak temperature	t_2	6 seconds
Temperature gradient in cooling		6°C/second max.

FIGURE 9-1: REFLOW PROFILE



8. Ordering Information

The following table provides the ordering information of the BTM923 module.

Table 8-1. Module Ordering Information

Module	Microchip IC	Description	Shield	Regulatory Certification	Part No.
BTM923	IS2023S-203	Bluetooth 5.0 BDR/EDR, Class 2 Surface Mount module with integrated antenna and shield.	Yes	FCC, IC, CE, MIC, KCC, NCC, SRRC, ANATEL, IFT, CNC	BM23SPKS1NB9

Note:

1. The module can only be purchased through a Microchip representative.
2. Go to <http://www.microchip.com/> for current pricing and a list of distributors carrying Microchip products.

9. Certification Notices

BM20 module (BM20SPKS1NBC) has received the regulatory approval for the following:

- BT SIG/QDID: 121137
- United States: FCC ID: A8TBM20SPKXYNBZ
- Canada
 - IC: 12246A-BM20SPKS1
 - HVIN: BM20SPKS1
- Europe/CE
- Japan/MIC: 202-SMD048
- Korea/KCC: MSIP-CRM-mcp-BM20SPKS1NBC
- Taiwan/NCC: CCAN15LP0460T2
- China/SRRC: CMIIT ID: 2015DJ7134
- Brazil/ANATEL: 01888-19-08759
- Mexico/IFT: RCPMIBM19-0454
- Argentina/CNC ID: C-22800

BM23 module (BM23SPKS1NB9) has received the regulatory approval for the following:

- BT SIG/QDID: 121137
- United States/ FCC ID: A8TBM23SPKXYC2A
- Canada
 - IC: 12246A-BM23SPKXYC2
 - HVIN: BM23SPKXY
- Europe/CE
- Japan/MIC: 202-SMC067
- Korea/KCC: MSIP-CRM-S9S-BM23SPKXY
- Taiwan
 - NCC: CCAL15LP0270T3
 - M/N: BM23SPK
- China/SRRC: CMIIT ID: 2016DJ3553

9.1 United States

The BM20/23 stereo audio module has received Federal Communications Commission (FCC) CFR47 Telecommunications, Part 15 Subpart C “Intentional Radiators” single-modular approval in accordance with Part 15.212 Modular Transmitter approval. Single-modular transmitter approval is defined as a complete RF transmission sub-assembly, designed to be incorporated into another device, that must demonstrate compliance with FCC rules and policies independent of any host. A transmitter with a modular grant can be installed in different end-use products (referred to as a host, host product, or host device) by the grantee or other equipment manufacturer, then the host product may not require additional testing or equipment authorization for the transmitter function provided by that specific module or limited module device.

The user must comply with all of the instructions provided by the Grantee, which indicate installation and/or operating conditions necessary for compliance.

The host product itself is required to comply with all other applicable FCC equipment authorizations regulations, requirements and equipment functions that are not associated with the transmitter module portion. For example, compliance must be demonstrated: to regulations for other transmitter components within a host product; to requirements for unintentional radiators (Part 15 Subpart B), such as digital devices, computer peripherals, radio receivers, etc.; and to additional authorization requirements for the non-transmitter functions on the transmitter module (i.e., Verification, or Declaration of Conformity) as appropriate (e.g., Bluetooth and Wi-Fi transmitter modules may also contain digital logic functions).

9.1.1 Labeling and User Information Requirements

The BM20/23 module has been labeled with its own FCC ID number. If the FCC ID is not visible when the module is installed inside another device, then the outside of the finished product into which the module is installed must also display a label referring to the enclosed module. These exterior labels use the following wording:

For BM20 Module:

Contains Transmitter Module FCC ID: A8TBM20SPKXYNBZ

or

Contains FCC ID: A8TBM20SPKXYNBZ

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation

For BM23 Module:

Contains Transmitter Module FCC ID: A8TBM23SPKXYC2A

or

Contains FCC ID: A8TBM23SPKXYC2A

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation

A user's manual for the product must include the following statement:

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy, and if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna
- Increase the separation between the equipment and receiver
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected
- Consult the dealer or an experienced radio/TV technician for help

Additional information on labeling and user information requirements for Part 15 devices can be found in KDB Publication 784748 available at the FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB) <https://apps.fcc.gov/oetcf/kdb/index.cfm>.

9.1.2 RF Exposure

All transmitters regulated by FCC must comply with RF exposure requirements. KDB 447498 General RF Exposure Guidance provides guidance in determining whether proposed or existing transmitting facilities, operations or devices comply with limits for human exposure to Radio Frequency (RF) fields adopted by the Federal Communications Commission (FCC).

For the BM20 Module:

- Output power listed is conducted. This device and its antenna(s) must not be co-located or operating in conjunction with any other antenna or transmitter, except in accordance with the FCC multi-transmitter product procedures. End-users must be provided with specific operating instructions for satisfying RF exposure compliance.
- This module is approved for installation into mobile or/and portable host platforms.

For the BM23 Module:

- Output power listed is conducted. This grant is valid only when the module is sold to OEM integrators and must be installed by the OEM or OEM integrators. This transmitter is restricted for use with the specific antenna(s) tested in this application for Certification and must not be co-located or operating in conjunction with any other antenna or transmitters within a host device, except in accordance with FCC multi-transmitter product procedures.
- This module is approved for installation into mobile or/and portable host platforms.

9.1.3 Helpful Websites

Federal Communications Commission (FCC): <http://www.fcc.gov>.

FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB): <https://apps.fcc.gov/oetcf/kdb/index.cfm>

9.2 Canada

The BM20/23 module has been certified for use in Canada under Innovation, Science, and Economic Development (ISED, formerly Industry Canada), Radio Standards Procedure (RSP) RSP-100, Radio Standards Specification (RSS) RSS-Gen and RSS-247. Modular approval permits the installation of a module in a host device without the need to recertify the device.

9.2.1 Labeling and User Information Requirements

Labeling Requirements (from RSP-100, Issue 11, Section 3): The host product shall be properly labeled to identify the module within the host device.

The Innovation, Science and Economic Development Canada certification label of a module shall be clearly visible at all times when installed in the host product. Otherwise, the host device must be labeled to display the Innovation, Science and Economic Development Canada certification number of the module, preceded by the word "Contains", or similar word expressing the same meaning, as follows:

For BM20 Module:

Contains IC: 12246A-BM20SPKS1

For BM23 Module:

Contains IC: 12246A-BM23SPKXYC2

User Manual Notice for License-Exempt Radio Apparatus (from Section 8.4 RSS-Gen, Issue 4, November 2014): User manuals for license-exempt radio apparatus shall contain the following or equivalent notice in a conspicuous location in the user manual, on the device or both:

This device complies with Industry Canada's license-exempt RSS standard(s). Operation is subject to the following two conditions:

(1) This device may not cause interference, and

(2) This device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

(1) l'appareil ne doit pas produire de brouillage, et

(2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Guidelines on Transmitter Antenna for License Exempt Radio Apparatus:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain must be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

9.2.2 RF Exposure

All transmitters regulated by the Innovation, Science and Economic Development Canada (ISED) must comply with RF exposure requirements listed in RSS-102 - Radio Frequency (RF) Exposure Compliance of Radio Communication Apparatus (All Frequency Bands).

This transmitter is restricted for use with a specific antenna tested in this application for certification, and must not be co-located or operating in conjunction with any other antenna or transmitters, except in accordance with Innovation, Science and Economic Development Canada multi-transmitter guidelines.

The device operates at an output power level which is within the ISED SAR test exemption limits at any user distance.

9.2.3 Helpful Websites

Innovation, Science and Economic Development Canada (ISED): <http://www.ic.gc.ca/Intro.html>.

9.3 Europe

The BM20/23 module is a Radio Equipment Directive (RED) assessed radio module that is CE marked and has been manufactured and tested with the intention of being integrated into a final product.

The BM20/23 module has been tested to RED 2014/53/EU Essential Requirements for Health and Safety (Article (3.1(a)), Electromagnetic Compatibility (EMC) (Article 3.1(b)), and Radio (Article 3.2), which is summarized in the [Table 9-1](#) and [Table 9-2](#) European Compliance Testing tables.

The ETSI provides guidance on modular devices in the *"Guide to the application of harmonised standards covering articles 3.1b and 3.2 of the RED 2014/53/EU (RED) to multi-radio and combined radio and nonradio equipment"* document available at http://www.etsi.org/deliver/etsi_eg/203300_203399/203367/01.01.01_60/eg_203367v010101p.pdf.

Note: To maintain conformance to the testing listed in [Table 9-1](#) and [Table 9-2](#), the modules shall be installed in accordance with the installation instructions in this data sheet and shall not be modified. When integrating a radio module into a completed product the integrator becomes the manufacturer of the final product and is therefore responsible for demonstrating compliance of the final product with the essential requirements against the RED.

9.3.1 Labeling and User Information Requirements

The label on the final product which contains the BM20/23 module must follow CE marking requirements.

The European Compliance Testing listed in the following tables was performed using the integral PCB antenna.

BM20/23

Certification Notices

Table 9-1. European Compliance Testing (BM20)

Certification	Standards	Article	Laboratory	Report Number	Date
Safety	EN 60950-1:2006 / A11:2009 / A1:2010 / A12:2011 / A2:2013	(3.1(a))	TUV Rheinland, Taiwan	10050720 002	15 Sep 2015
Health	EN 300 328 V1.9.1 / EN 62479:2010			10050932 002	09 Sep 2015
EMC	EN 301 489-1 V1.9.2	(3.1(b))		10050691 002	16 Sep 2015
	EN 301 489-17 V2.2.1				
	EN 301 489-1 V2.1.1			10050691 003	26 May 2017
	EN 301 489-1 V2.2.0				
	EN 301 489-17 V3.1.1				
	EN 301 489-17 V3.2.0				
Radio	EN 300 328 V1.9.1	(3.2)		10050932 002	09 Sep 2015
	EN 300 328 V2.1.1			10050932 003	26 May 2017

Table 9-2. European Compliance Testing (BM23)

Certification	Standards	Article	Laboratory	Report Number	Date
Safety	EN 60950-1:2006 / A11:2009 / A1:2010 / A12:2011 / A2:2013	(3.1(a))	TUV Rheinland, Taiwan	10047732 002	26 May 2017
Health	EN 300 328 V1.9.1 / EN 62479:2010			10048076 001 & 10048076 002	15 Sep 2014 & 26 Oct 2015
EMC	EN 301 489-1 V1.9.2	(3.1(b))		10047659 001	23 Sep 2014
	EN 301 489-17 V2.2.1				
	EN 301 489-1 V2.1.1			10047659 002	26 May 2017
	EN 301 489-1 V2.2.0				
	EN 301 489-17 V3.1.1				
	EN 301 489-17 V3.2.0				
Radio	EN 300 328 V1.9.1	(3.2)		10048076 001 & 10048076 002	15 Sep 2014 & 26 Oct 2015
	EN 300 328 V2.1.1			10048076 003	26 May 2017

9.3.2 Conformity Assessment

From ETSI Guidance Note EG 203367, section 6.1 Non-radio products are combined with a radio product:

If the manufacturer of the combined equipment installs the radio product in a host non-radio product in equivalent assessment conditions (i.e. host equivalent to the one used for the assessment of the radio product) and according to the installation instructions for the radio product, then no additional assessment of the combined equipment against article 3.2 of the RED is required.

The European Compliance Testing listed in [Table 9-1](#) and [Table 9-2](#) was performed using the integral PCB antenna.

9.3.3 Simplified EU Declaration of Conformity

Hereby, Microchip Technology Inc. declares that the radio equipment type BM20/23 module is in compliance with Directive 2014/53/EU.

The full text of the EU declaration of conformity, for this product, is available at <http://www.microchip.com/design-centers/wireless-connectivity>.

9.3.4 Helpful Websites

A document that can be used as a starting point in understanding the use of Short Range Devices (SRD) in Europe is the European Radio Communications Committee (ERC) Recommendation 70-03 E, which can be downloaded from the European Communications Committee (ECC): <http://www.ecodocdb.dk/>.

Additional helpful websites are:

- Radio Equipment Directive (2014/53/EU): https://ec.europa.eu/growth/single-market/european-standards/harmonised-standards/red_en.
- European Conference of Postal and Telecommunications Administrations (CEPT): <http://www.cept.org>.
- European Telecommunications Standards Institute (ETSI): <http://www.etsi.org>.
- The Radio Equipment Directive Compliance Association (REDCA): <http://www.redca.eu/>.

9.4 Japan

The BM20/23 module has received type certification and is labeled with its own technical conformity mark and certification number as required to conform to the technical standards regulated by the Ministry of Internal Affairs and Communications (MIC) of Japan pursuant to the Radio Act of Japan.

Integration of this module into a final product does not require additional radio certification provided installation instructions are followed and no modifications of the module are allowed. Additional testing may be required:

- If the host product is subject to electrical appliance safety (for example, powered from an AC mains), the host product may require Product Safety Electrical Appliance and Material (PSE) testing. The integrator should contact their conformance laboratory to determine if this testing is required.
- There is a voluntary Electromagnetic Compatibility (EMC) test for the host product administered by VCCI: http://www.vcci.jp/vcci_e/index.html.

9.4.1 Labeling and User Information Requirements

The label on the final product which contains the BM20/23 module must follow Japan marking requirements. The integrator of the module should refer to the labeling requirements for Japan available at the Ministry of Internal Affairs and Communications (MIC) website.

The BM20/23 module is labeled with its own technical conformity mark and certification number. The final product in which this module is being used must have a label referring to the type of certified module inside:

Figure 9-1. BM20 Module

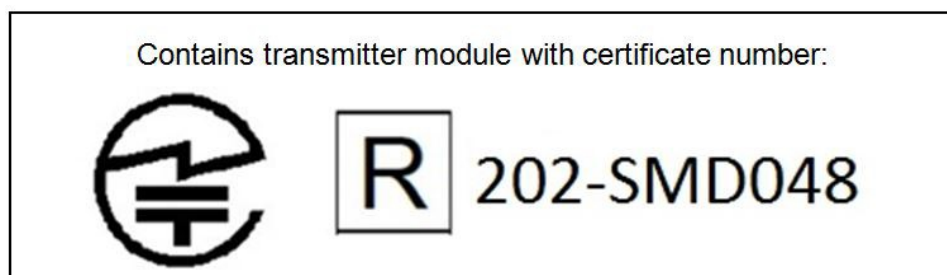
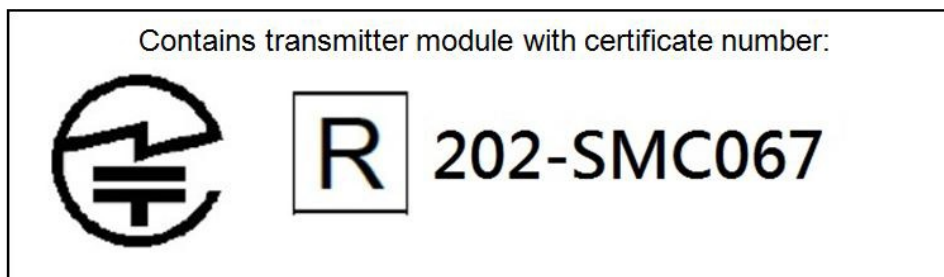


Figure 9-2. BM23 Module



9.4.2 Helpful Websites

Ministry of Internal Affairs and Communications (MIC): <http://www.tele.soumu.go.jp/e/index.htm>.

Association of Radio Industries and Businesses (ARIB): <http://www.arib.or.jp/english/>.

9.5 Korea

The BM20/23 module has received certification of conformity in accordance with the Radio Waves Act. Integration of this module into a final product does not require additional radio certification provided installation instructions are followed and no modifications of the module are allowed.

9.5.1 Labeling and User Information Requirements

The label on the final product that contains the BM20/23 module must follow KC marking requirements. The integrator of the module should refer to the labeling requirements for Korea available on the Korea Communications Commission (KCC) website.

The BM20/23 module is labeled with its own KC mark. The final product requires the KC mark and certificate number of the module:

Figure 9-3. BM20 Module

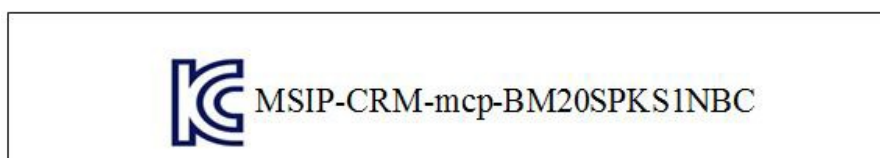
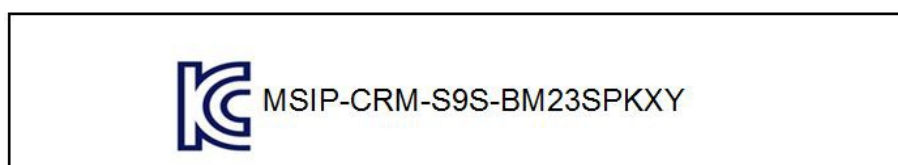


Figure 9-4. BM23 Module



9.5.2 Helpful Websites

Korea Communications Commission (KCC): <http://www.kcc.go.kr>.

National Radio Research Agency (RRA): <http://rra.go.kr>.

9.6 Taiwan

The BM20/23 module has received compliance approval in accordance with the Telecommunications Act. Customers seeking to use the compliance approval in their product should contact the Microchip Technology Inc. sales office or distribution partners to obtain a Letter of Authority.

Integration of this module into a final product does not require additional radio certification provided installation instructions are followed and no modifications of the module are allowed.

9.6.1 Labeling and User information Requirements

The BM20/23 module is labeled with its own NCC mark and certificate number as below:

Figure 9-5. BM20 Module

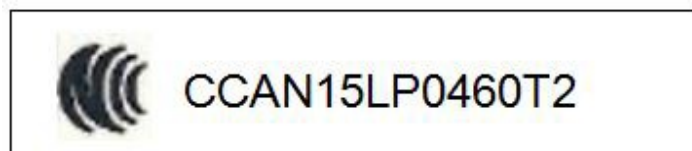
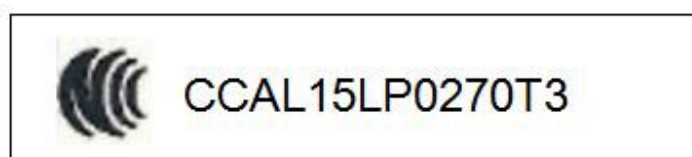


Figure 9-6. BM23 Module



The user's manual should contain below warning (for RF device) in traditional Chinese:

注意！

依據 低功率電波輻射性電機管理辦法

第十二條 經型式認證合格之低功率射頻電機，非經許可，公司、商號或使用者均不得擅自變更頻率、加大功率或變更原設計之特性及功能。

第十四條 低功率射頻電機之使用不得影響飛航安全及干擾合法通信；經發現有干擾現象時，應立即停用，並改善至無干擾時方得繼續使用。前項合法通信，指依電信規定作業之無線電信。低功率射頻電機須忍受合法通信或工業、科學及醫療用電波輻射性電機設備之干擾。

9.6.2 Helpful Websites

National Communications Commission (NCC): <http://www.ncc.gov.tw>.

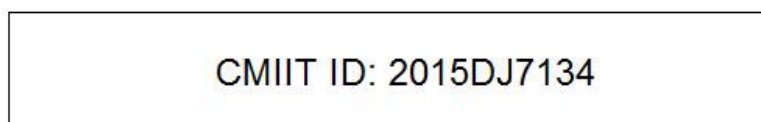
9.7 China

The BM20/23 module has received certification of conformity in accordance with the China MIIT Notice 2014-01 of State Radio Regulation Committee (SRRC) certification scheme. Integration of this module into a final product does not require additional radio certification, provided installation instructions are followed and no modifications of the module are allowed.

9.7.1 Labeling and User Information Requirements

The BM20 module is labeled with its own CMIIT ID as follows:

Figure 9-7. BM20 CMIIT ID



When Host system is using an approved Full Modular Approval (FMA) radio: The host should bear a label containing the statement "This device contains SRRC approved Radio module CMIIT ID 2015DJ7134".

The BM23 module is labeled with its own CMIIT ID as follows:

Figure 9-8. BM23 CMIIT ID



When Host system is using an approved Full Modular Approval (FMA) radio: The host should bear a label containing the statement "This device contains SRRC approved Radio module CMIIT ID 2016DJ3553".

9.8 Brazil

The BM20 received compliance approval in accordance with the Telecommunications Act of the Federal Republic of Brazil National Telecommunications Agency (ANATEL). Customers seeking to use the compliance approval in their product must contact Microchip Technology Inc. sales or distribution partners to obtain a Letter of Authority.

Modelo: BM20SPKS1NBC



01888-19-08759

Este equipamento opera em caráter secundário, isto é, não tem direito a proteção contra interferência prejudicial, mesmo de estações do mesmo tipo, e não pode causar interferência a sistemas operando em caráter primário

The End product (Host) manual must include the following statement:

Este product contém a placa Modelo BM20SPKS1NBC código de homologação ANATEL 01888-19-08759.

9.9 Mexico

The BM20 module has received compliance approval in accordance with the IFT (IFETEL) of Mexico.

Customers seeking to use the compliance approval in their product must contact Microchip Technology Inc. sales or distribution partners to obtain a Letter of Authority.

Integration of this module into a final product does not require additional radio certification provided installation instructions are followed and no modifications of the module are allowed.

Operation of this equipment is subject to the following two conditions: (1) this device or device may not cause harmful interference, and (2) this device or device must accept any interference, including interference that may cause undesired operation.

La operación de este equipo está sujeta a las siguientes dos condiciones: (1) es posible que este equipo o dispositivo no cause interferencia perjudicial y (2) este equipo o dispositivo debe aceptar cualquier interferencia, incluyendo la que pueda causar su operación no deseada.

9.9.1 Labeling and User Information Requirements

The BM20 module, due to limited module size, the IFT mark and ID are displayed in the data sheet and/or packaging label and cannot be displayed on the module label.

IFT: RCPMIBM19-0454

9.10 Argentina

The BM20 module has received compliance approval in accordance with the Argentine NATIONAL ENTITY OF COMMUNICATIONS (ENACOM).

Customers seeking to use the compliance approval in their product must contact Microchip Technology Inc. sales or distribution partners to obtain a Letter of Authority.

Integration of this module into a final product does not require additional radio certification provided installation instructions are followed and no modifications of the module are allowed.

9.10.1 Labeling and User Information Requirements

BM20 module, due to limited module size, the CNC mark and Certificate number are displayed in the data sheet and/or packaging label and cannot be displayed on the module label



When Host (End Product) system is using an approved radio:

The external label must be composed of the module CNC Registration Number, preceded by the legend: "Contiene Módulo CNC ID" or "Contiene CNC ID" sentence, as shown below:

Contiene Módulo CNC ID: C-22800

9.11 Other Regulatory Jurisdictions

- For information on the other countries' jurisdictions covered, refer to <https://www.microchip.com/design-centers/wireless-connectivity/certifications>.
 - Should other regulatory jurisdiction certifications be required by the customer, or the customer needs to recertify the module for other reasons, contact Microchip for the required utilities and documentation.
-